



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

Power TOPLED®

Enhanced optical Power LED (HOP2000)

LS E67B, LA E67B, LO E67B, LY E67B



Vorläufige Daten / Preliminary Data

Besondere Merkmale

- **Gehäusetyp:** weißes P-LCC-4 Gehäuse
- **Besonderheit des Bauteils:** mehr Licht durch erhöhten optischen Wirkungsgrad; höhere Umgebungstemperatur bei gleichem Strom im Vergleich zur TOPLED®
- **Wellenlänge:** 633 nm (super-rot), 617 nm (amber), 606 nm (orange), 587 nm (gelb)
- **Abstrahlwinkel:** Lambertscher Strahler (120°)
- **Technologie:** InGaAlP
- **optischer Wirkungsgrad:** 24 lm/W (amber, orange, gelb), 18 lm/W (super-rot)
- **Gruppierungsparameter:** Lichtstärke, Durchflussspannung, Wellenlänge
- **Verarbeitungsmethode:** für alle SMT-Bestücktechniken geeignet
- **Lötmethode:** IR Reflow Löten und Wellenlöten (TTW)
- **Vorbehandlung:** nach JEDEC Level 2
- **Gurtung:** 8 mm Gurt mit 2000/Rolle, ø180 mm oder 8000/Rolle, ø330 mm
- **ESD-Festigkeit:** ESD-sicher bis 2 kV nach EOS/ESD-5.1-1993

Anwendungen

- Ampelanwendung
- Hinterleuchtung (LCD, Schalter, Tasten, Displays, Werbebeleuchtung)
- Innen- und Außenbeleuchtung im Automobilbereich (z.B. Instrumentenbeleuchtung, Blinker, seitl. Begrenzungsleuchten, Bremslichter)
- Ersatz von Kleinst-Glühlampen
- Markierungsbeleuchtung (z.B. Fluchtwege, u.ä.)
- Signal- und Symbolleuchten

Features

- **package:** white P-LCC-4 package
- **feature of the device:** more light due to higher optical efficiency, higher ambient temperature at the same current possible compared to TOPLED®
- **wavelength:** 633 nm (super-rot), 617 nm (amber), 606 nm (orange), 587 nm (gelb)
- **viewing angle:** Lambertian Emitter (120°)
- **technology:** InGaAlP
- **optical efficiency:** 24 lm/W (amber, orange, yellow), 18 lm/W (super-red)
- **grouping parameter:** luminous intensity, forward voltage, wavelength
- **assembly methods:** suitable for all SMT assembly methods
- **soldering methods:** IR reflow soldering and TTW soldering
- **preconditioning:** acc. to JEDEC Level 2
- **taping:** 8 mm tape with 2000/reel, ø180 mm or 8000/reel, ø330 mm
- **ESD-withstand voltage:** up to 2 kV acc. to EOS/ESD-5.1-1993

Applications

- traffic lights
- backlighting (LCD, switches, keys, displays, illuminated advertising)
- interior and exterior automotive lighting (e.g. dashboard backlighting, turn signal lamps, sidemarkers, brake lights)
- substitution of micro incandescent lamps
- marker lights (e.g. exit ways, etc.)
- signal and symbol luminaire

LS E67B, LA E67B, LO E67B, LY E67B

Typ Type	Emissions-farbe Color of Emission	Farbe der Lichtaustrittsfläche Color of the Light Emitting Area	Lichtstärke Luminous Intensity $I_F = 50 \text{ mA}$ $I_V (\text{mcd})$	Lichtstrom Luminous Flux $I_F = 50 \text{ mA}$ $\Phi_V (\text{lm})$	Bestellnummer Ordering Code
LS E67B-T2V1-1-1	super-red	colorless clear	355 ... 900	1900 (typ.)	Q65110A0178
LA E67B-U2AA-24-1	amber	colorless clear	560 ... 1400	2900 (typ.)	Q62703Q5965
LO E67B-U2AA-24-1	orange	colorless clear	560 ... 1400	2900 (typ.)	Q62703Q6010
LY E67B-U2AA-26-1	yellow	colorless clear	560 ... 1400	2900 (typ.)	Q62703Q6329

Anm.: -1-1 gesamter Farbbereich (siehe Seite 4)

-24-1 gesamter Farbbereich, Lieferung in Einzelgruppen (siehe Seite 5)

-26-1 gesamter Farbbereich, Lieferung in Einzelgruppen (siehe Seite 5)

-24-1 gesamter Durchlassspannungsbereich, Lieferung in Einzelgruppen (siehe Seite 5)

-26-1 gesamter Durchlassspannungsbereich, Lieferung in Einzelgruppen (siehe Seite 5)

Die Standardlieferform von Serientypen beinhaltet eine Familiengruppe, die aus nur 4 Halbgruppen besteht. Einzelne Halbgruppen sind nicht erhältlich.

In einer Verpackungseinheit / Gurt ist immer nur eine Halbgruppe enthalten.

Dimmverhältnis im Gleichstrom-Betrieb max. 5:1

Note: -1-1 Total color tolerance range (please see page 4)

-24-1 Total color tolerance range, delivery in single groups (please see page 5)

-26-1 Total color tolerance range, delivery in single groups (please see page 5)

-24-1 Total forward voltage tolerance, delivery in single groups (see page 5)

-26-1 Total forward voltage tolerance, delivery in single groups (see page 5)

The standard shipping format for serial types includes a group of only 4 individual groups. Individual half groups are not available.

No packing unit / tape ever contains more than one luminous intensity half group.

Dimming range for direct current mode max. 5:1

Grenzwerte

Maximum Ratings

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Betriebstemperatur Operating temperature range	T_{op}	- 40 ... + 100	°C
Lagertemperatur Storage temperature range	T_{stg}	- 40 ... + 100	°C
Sperrschichttemperatur Junction temperature	T_j	+ 125	°C
Durchlassstrom Forward current	I_F	70	mA
Stoßstrom Surge current $t \leq 10 \mu\text{s}, D = 0.1$	I_{FM}	0.1	A
Sperrspannung ¹⁾ Reverse voltage	V_R	12	V
Leistungsaufnahme Power consumption	P_{tot}	180	mW
Wärmewiderstand Thermal resistance Sperrsicht/Umgebung Junction/ambient Sperrsicht/Löt pad Junction/soldering point Montage auf PC-Board FR 4 (Padgröße $\geq 16 \text{ mm}^2$) mounted on PC board FR 4 (pad size $\geq 16 \text{ mm}^2$)	$R_{th JA}$ $R_{th JS}$	300 130	K/W K/W

¹⁾ für kurzzeitigen Betrieb geeignet / suitable for short term application

Kennwerte ($T_A = 25^\circ\text{C}$)

Characteristics

Bezeichnung Parameter	Symbol Symbol	Werte Values				Einheit Unit
		LS	LA	LO	LY	
Wellenlänge des emittierten Lichtes (typ.) Wavelength at peak emission $I_F = 50 \text{ mA}$	λ_{peak}	645	624	610	594	nm
Dominantwellenlänge ¹⁾ (typ.) Dominant wavelength $I_F = 50 \text{ mA}$	λ_{dom}	633 ± 6	617 $-5/+7$	606 $-6/+3$	587 $-7/+8$	nm
Spektrale Bandbreite bei 50 % $I_{\text{rel max}}$ (typ.) Spectral bandwidth at 50 % $I_{\text{rel max}}$ $I_F = 50 \text{ mA}$	$\Delta\lambda$	15	18	16	15	nm
Abstrahlwinkel bei 50 % I_V (Vollwinkel) (typ.) Viewing angle at 50 % I_V	2ϕ	120	120	120	120	Grad deg.
Durchlassspannung ²⁾ (min.) Forward voltage (typ.) $I_F = 50 \text{ mA}$ (max.)	V_F	1.9 ³⁾	1.9 ⁴⁾	1.9	1.9 ³⁾	V
Sperrstrom (typ.) Reverse current (max.) $V_R = 12 \text{ V}$	I_R	0.01 I_R	0.01 10	0.01 10	0.01 10	μA μA
Temperaturkoeffizient von λ_{peak} (typ.) Temperature coefficient of λ_{peak} $I_F = 50 \text{ mA}; -10^\circ\text{C} \leq T \leq 100^\circ\text{C}$	$TC_{\lambda_{\text{peak}}}$	0.15	0.15	0.14	0.13	nm/K
Temperaturkoeffizient von λ_{dom} (typ.) Temperature coefficient of λ_{dom} $I_F = 50 \text{ mA}; -10^\circ\text{C} \leq T \leq 100^\circ\text{C}$	$TC_{\lambda_{\text{dom}}}$	0.05	0.07	0.08	0.10	nm/K
Temperaturkoeffizient von V_F (typ.) Temperature coefficient of V_F $I_F = 50 \text{ mA}; -10^\circ\text{C} \leq T \leq 100^\circ\text{C}$	TC_V	-3.4	-3.7	-3.7	-3.7	mV/K
Optischer Wirkungsgrad (typ.) Optical efficiency $I_F = 50 \text{ mA}$	η_{opt}	18	24	24	24	lm/W

¹⁾ Wellenlängen werden mit einer Stromeinprägedauer von 25 ms und einer Genauigkeit von $\pm 1 \text{ nm}$ ermittelt.
Wavelengths are tested at a current pulse duration of 25 ms and a tolerance of $\pm 1 \text{ nm}$.

²⁾ Durchlassspannungsgruppen werden mit einer Stromeinprägedauer von 1 ms und einer Genauigkeit von $\pm 0,05 \text{ V}$ ermittelt.
Forward voltage groups are tested at a current pulse duration of 1 ms and a tolerance of $\pm 0,05 \text{ V}$.

**1) Wellenlängengruppen
Wavelength groups**

Gruppe Group	amber		orange		yellow		Einheit Unit
	min.	max.	min.	max.	min.	max.	
2	612	616	600	603	580	583	nm
3	616	620	603	606	583	586	nm
4	620	624	606	609	586	589	nm
5					589	592	nm
6					592	595	nm

**3) Durchlassspannungsgruppen für
super-rot / orange / gelb
Forward voltage groups for
super-red / orange / yellow**

Gruppe Group	Durchlassspannung Forward voltage		Einheit Unit
	min.	max.	
3	1.9	2.2	V
4	2.2	2.5	V

**4) Durchlassspannungsgruppen für amber
Forward voltage groups for amber**

Gruppe Group	Durchlassspannung Forward voltage		Einheit Unit
	min.	max.	
3A	1.90	2.05	V
3B	2.05	2.20	V
4A	2.20	2.35	V
4B	2.35	2.50	V

**Helligkeits-Gruppierungsschema
Luminous Intensity Groups**

Lichtgruppe Luminous Intensity Group	Lichtstärke Luminous Intensity I_V (mcd)	Lichtstrom Luminous Flux Φ_V (mlm)
T2	355 ... 450	1200 (typ.)
U1	450 ... 560	1500 (typ.)
U2	560 ... 710	1900 (typ.)
V1	710 ... 900	2400 (typ.)
V2	900 ... 1120	3000 (typ.)
AA	1120 ... 1400	3750 (typ.)

Helligkeitswerte werden mit einer Stromeinprägedauer von 25 ms und einer Genauigkeit von $\pm 11\%$ ermittelt.
Luminous intensity is tested at a current pulse duration of 25 ms and a tolerance of $\pm 11\%$.

**Gruppenbezeichnung auf Etikett
Group Name on Label**

Beispiel: AA-3-4A

Example: AA-3-4A

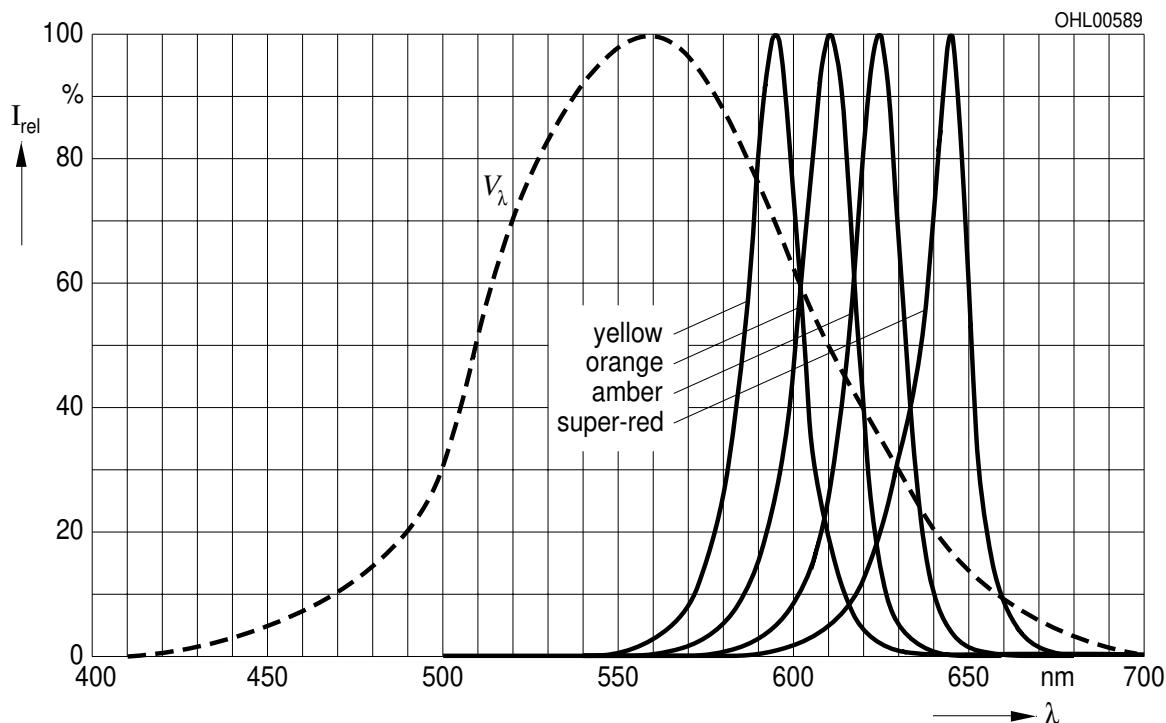
Lichtgruppe Luminous Intensity Group	Halbgruppe Half Group	Wellenlänge Wavelength	Durchlassspannung Forward Voltage
A	A	3	4A

Relative spektrale Emission $I_{\text{rel}} = f(\lambda)$, $T_A = 25^\circ \text{C}$, $I_F = 50 \text{ mA}$

Relative Spectral Emission

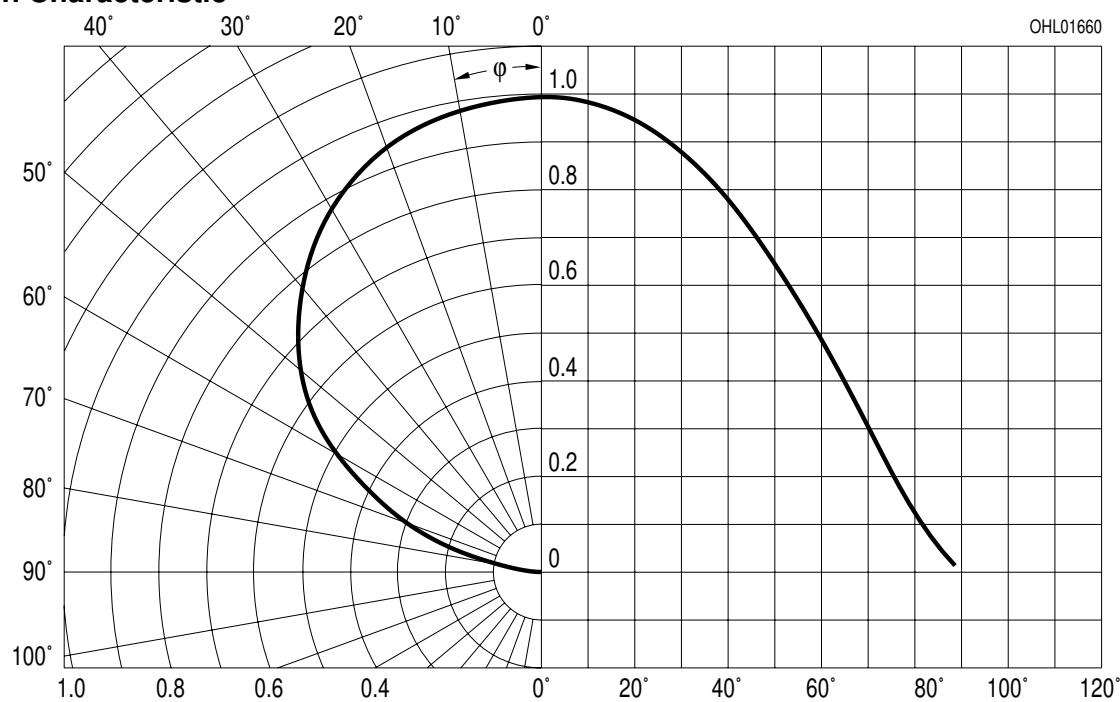
$V(\lambda) = \text{spektrale Augenempfindlichkeit}$

Standard eye response curve



Abstrahlcharakteristik $I_{\text{rel}} = f(\varphi)$

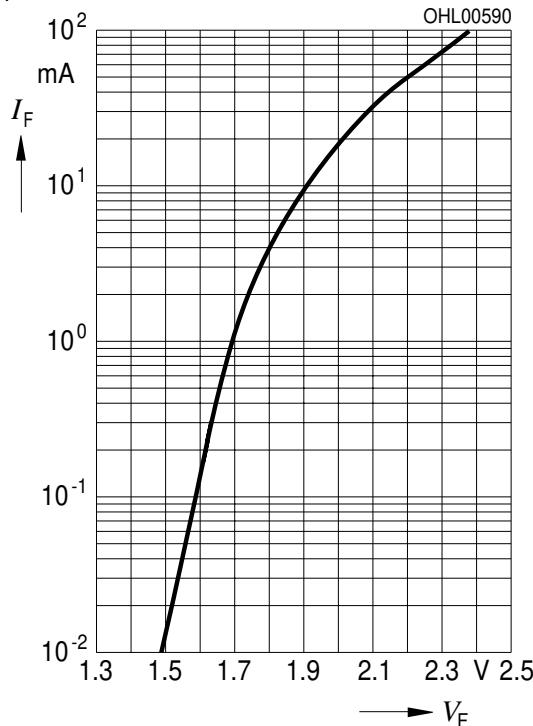
Radiation Characteristic



Durchlassstrom $I_F = f(V_F)$

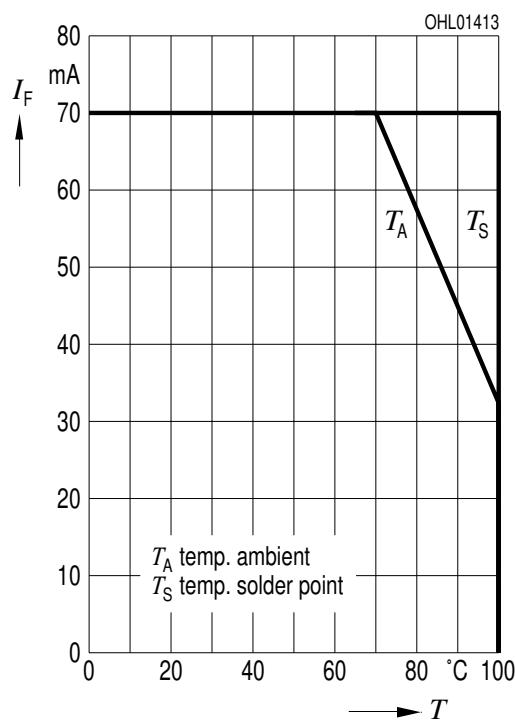
Forward Current

$T_A = 25^\circ\text{C}$



Maximal zulässiger Durchlassstrom $I_F = f(T)$

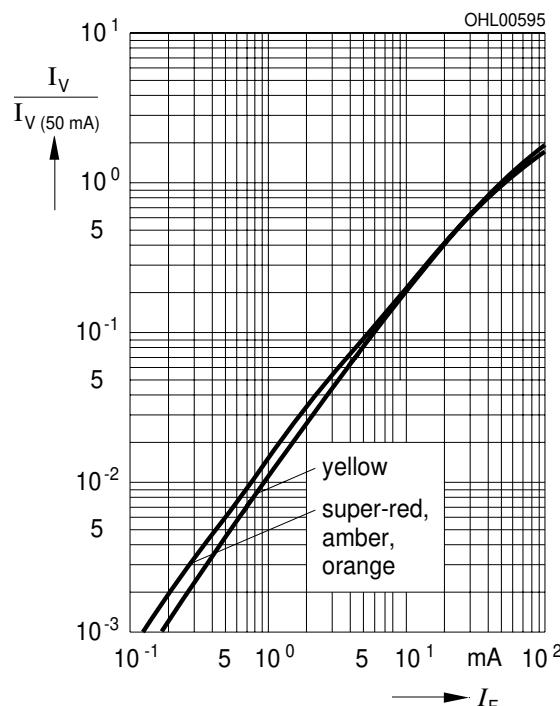
Max. Permissible Forward Current



Relative Lichtstärke $I_V/I_{V(50\text{ mA})} = f(I_F)$

Relative Luminous Intensity

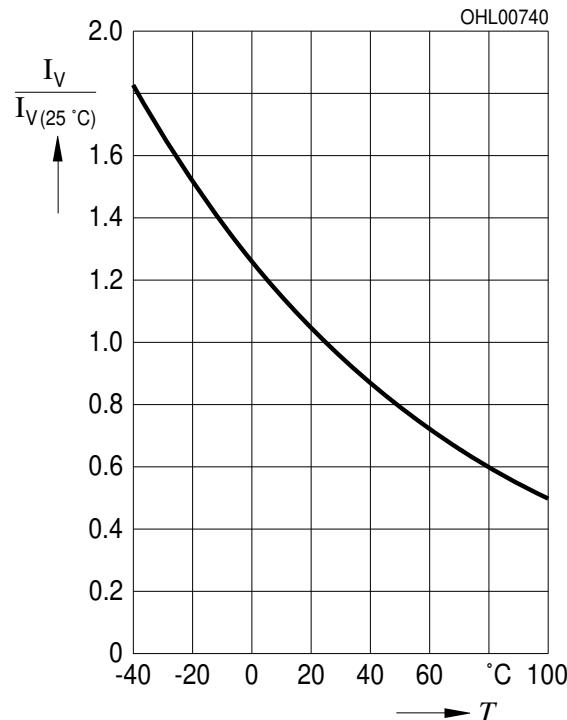
$T_A = 25^\circ\text{C}$



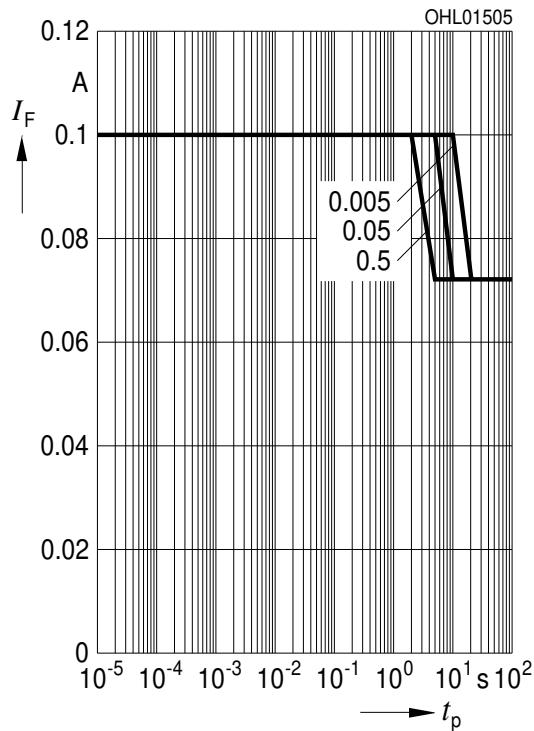
Relative Lichtstärke $I_V/I_{V(25^\circ\text{C})} = f(T_A)$

Relative Luminous Intensity

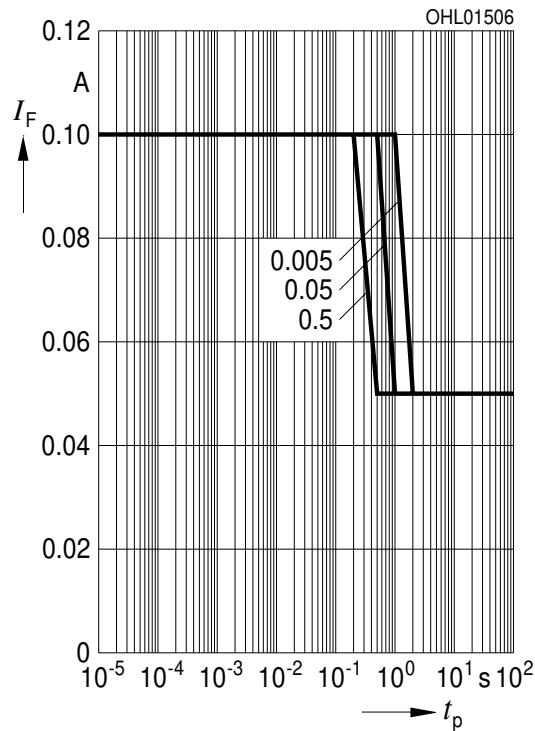
$I_F = 50$ mA



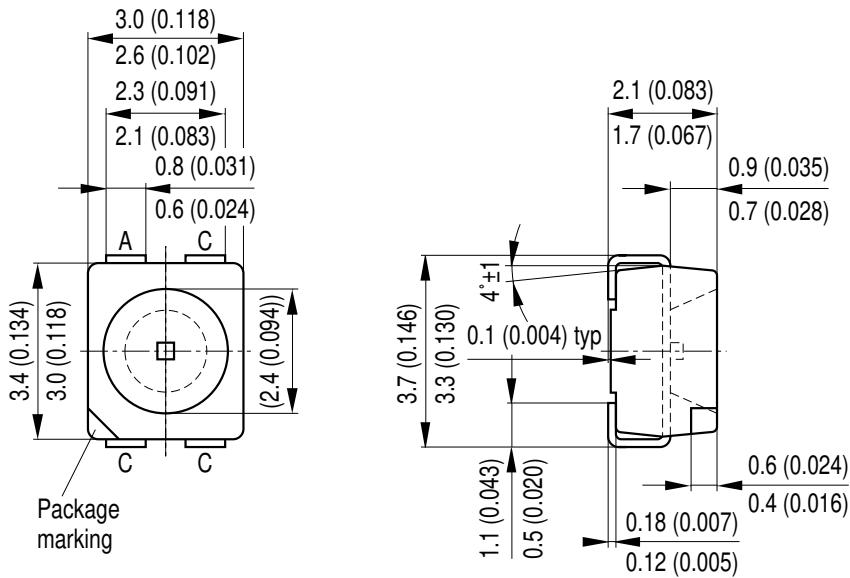
Zulässige Impulsbelastbarkeit $I_F = f(t_p)$
Permissible Pulse Handling Capability
Duty cycle D = parameter, $T_A = 25^\circ\text{C}$



Zulässige Impulsbelastbarkeit $I_F = f(t_p)$
Permissible Pulse Handling Capability
Duty cycle D = parameter, $T_A = 85^\circ\text{C}$



**Maßzeichnung
Package Outlines**

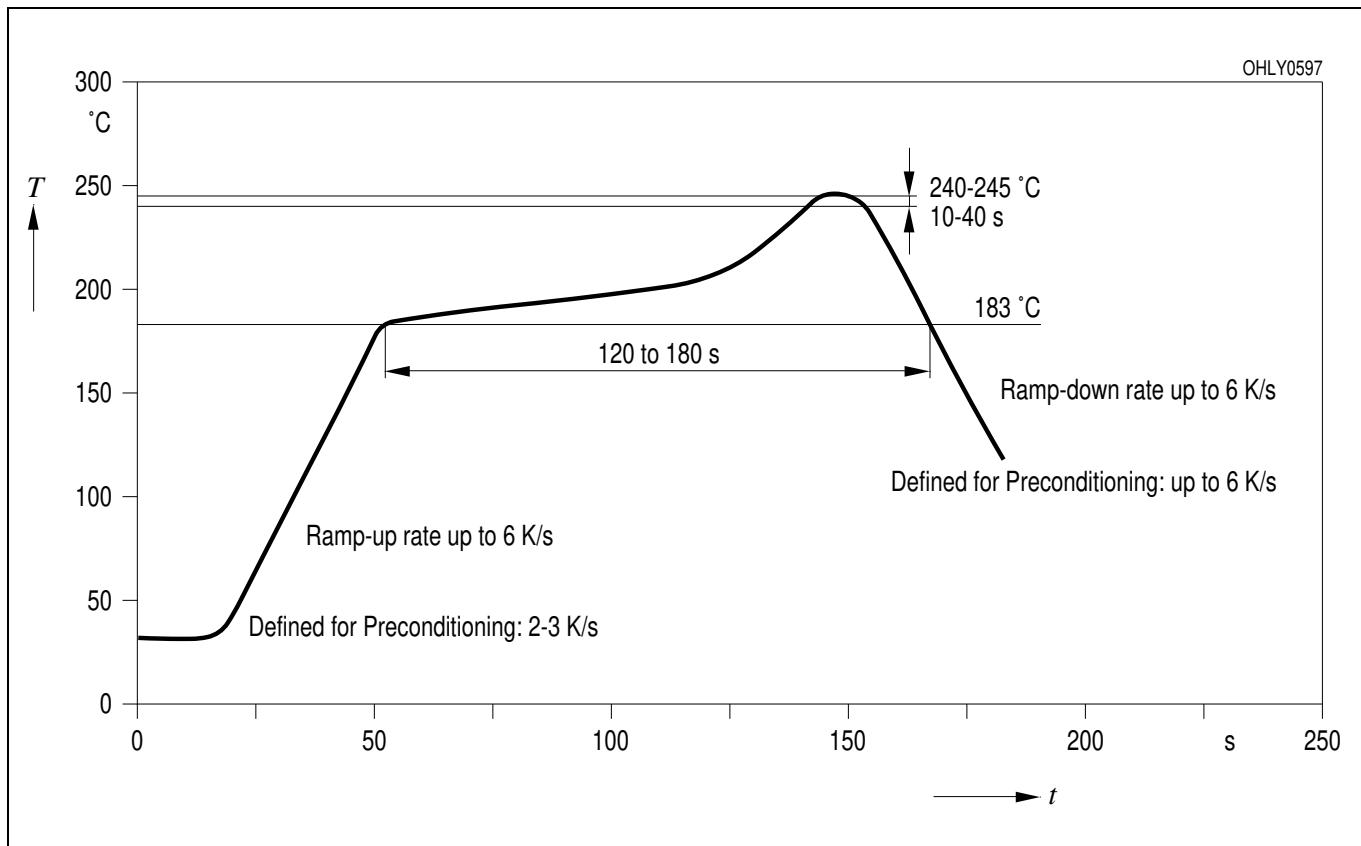


Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

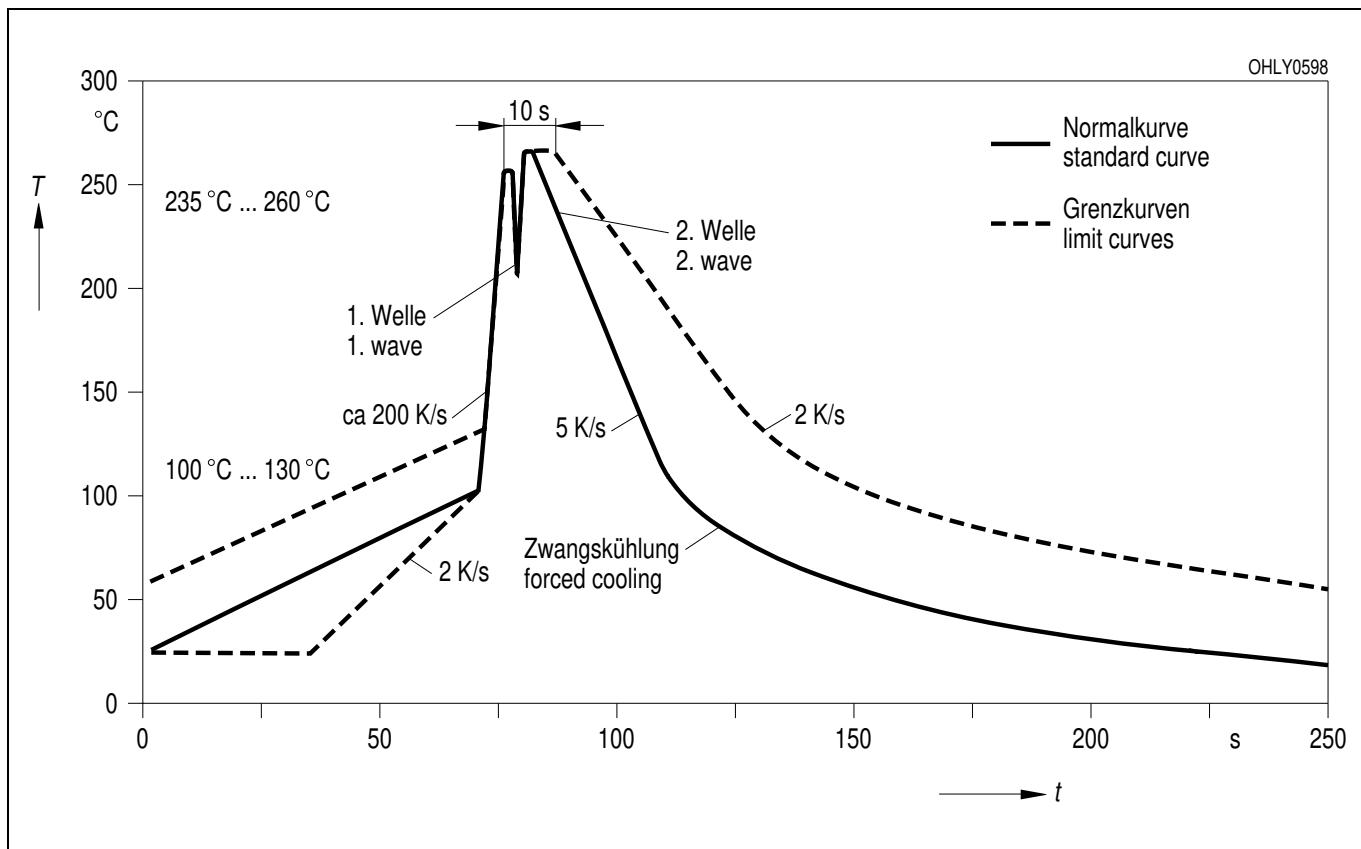
Gewicht / Approx. weight: 35 mg

Lötbedingungen Vorbehandlung nach JEDEC Level 2
Soldering Conditions Preconditioning acc. to JEDEC Level 2

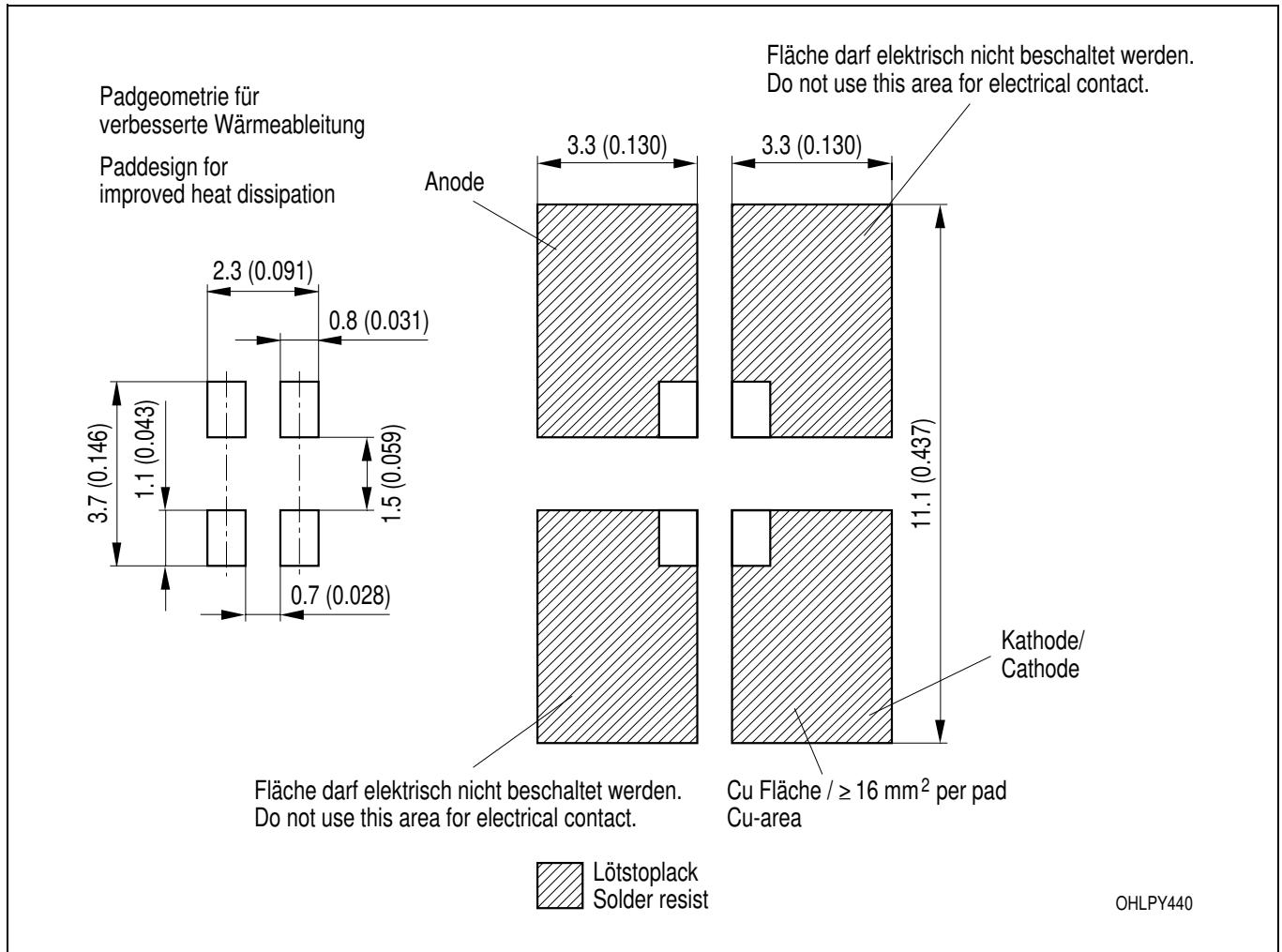
IR-Reflow Lötprofil (nach IPC 9501)
IR Reflow Soldering Profile (acc. to IPC 9501)



Wellenlöten (TTW) (nach CECC 00802)
TTW Soldering (acc. to CECC 00802)

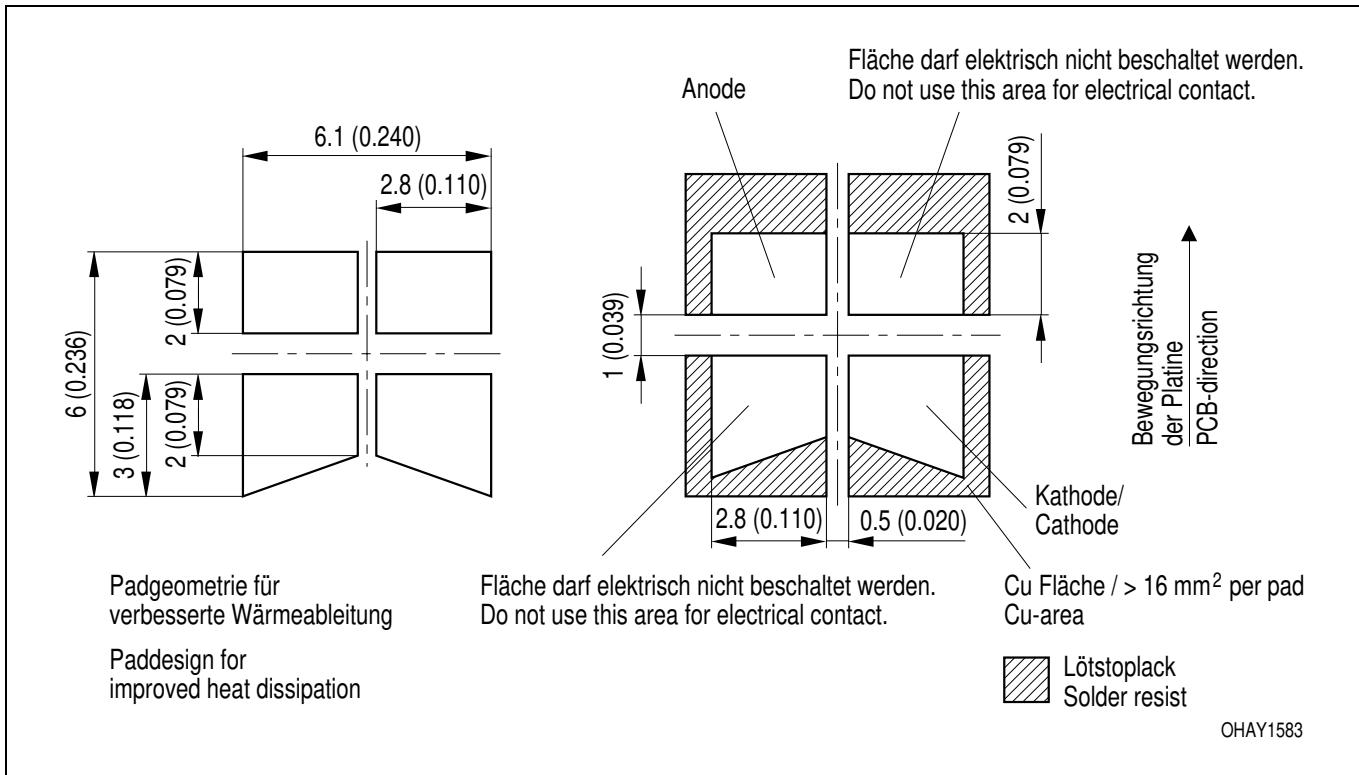


Empfohlenes Lötpaddesign IR Reflow Löten
Recommended Solder Pad IR Reflow Soldering



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

Empfohlenes Lötpaddesign Wellenlöten (TTW)
Recommended Solder Pad TTW Soldering



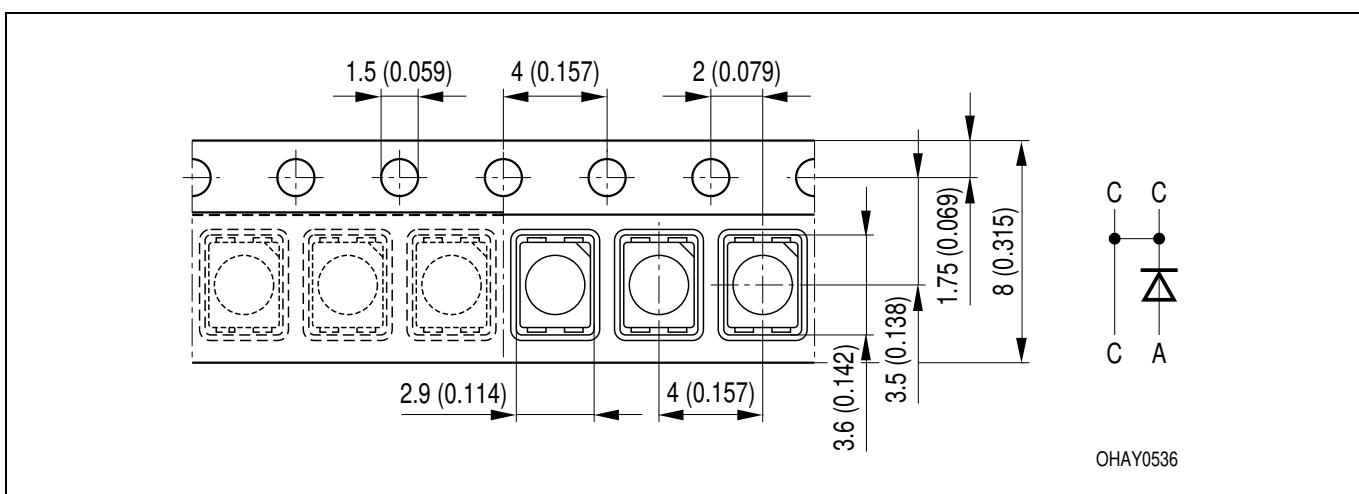
Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

Gurtung / Polarität und Lage

Verpackungseinheit 2000/Rolle, ø180 mm
oder 8000/Rolle, ø330 mm

Method of Taping / Polarity and Orientation

Packing unit 2000/reel, ø180 mm
or 8000/reel, ø330 mm



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

Revision History: 2003-05-26		Date of change
Previous Version: 2003-03-04		
Page	Subjects (major changes since last revision)	
2	wavelength grouping for yellow, amber and orange	
2	forward voltage grouping for yellow, amber and super-red	
7	change of diagram rel. lum. intensity (T_A) from OHL00569 to OHL00740	
4	value (orange; temperature coefficient of V_F from -1.8 to -3.7 mV/K)	2002-06-14
14	annotations	2002-07-25
4	value ($TC_{\lambda,dom}$ from 0.04 to 0.05 nm/K)	2002-07-25
12	new IR solder pad (OHLPY439 to OHLPY440)	2002-08-05
3, 4	value (reverse voltage from 5 V to 12 V)	2002-09-18
5	forward voltage groups for orange	2002-10-25
2	ordering code for super-red	2003-02-11
13	new recommended solder pad	2003-05-26

Published by OSRAM Opto Semiconductors GmbH

Wernerwerkstrasse 2, D-93049 Regensburg

© All Rights Reserved.

Attention please!

The information describes the type of component and shall not be considered as assured characteristics.
All typical data and graphs are basing on representative samples, but don't represent the production range. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances. For information on the types in question please contact our Sales Organization.
If printed or downloaded, please find the latest version in the Internet.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Components used in life-support devices or systems must be expressly authorized for such purpose! Critical components¹ may only be used in life-support devices or systems² with the express written approval of OSRAM OS.

¹ A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or the effectiveness of that device or system.

² Life support devices or systems are intended (a) to be implanted in the human body, or (b) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health of the user may be endangered.